

Final datasheet

XHP™2 module with CoolSiC™ Trench MOSFET

Features

- Electrical features
 - $V_{DSS} = 3300 \text{ V}$
 - $I_{DN} = 750 \text{ A} / I_{DRM} = 1500 \text{ A}$
 - $T_{vj,op} = 175^\circ\text{C}$
 - Low switching losses
 - High current density
 - Low inductive design
- Mechanical features
 - High power density
 - Package with CTI > 600
 - High creepage and clearance distances
 - AlSiC base plate for increased thermal cycling capability
 - AlN substrate with low thermal resistance



Potential applications

- Traction drives
- High-power converters
- High-frequency switching application

Product validation

- Qualified for industrial applications according to the relevant tests of IEC 60747, 60749 and 60068

Description

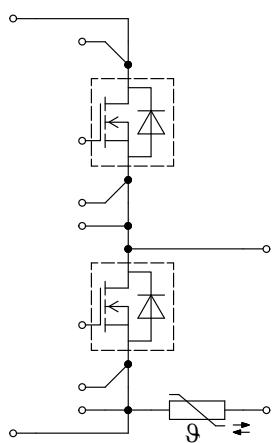


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1 Package

1 Package

Table 1 Insulation coordination

Parameter	Symbol	Note or test condition	Values	Unit
Isolation test voltage	V_{ISOL}	RMS, $f = 50 \text{ Hz}$, $t = 1 \text{ min}$	6.0	kV
Partial discharge extinction voltage	V_{isol}	RMS, $f = 50 \text{ Hz}$, $Q_{PD} \leq 10 \text{ pC}$	2.6	kV
DC stability	$V_{CE(D)}$	$T_{vj} = 25^\circ\text{C}$, 100 Fit	2100	V
Material of module baseplate			AlSiC	
Creepage distance	$d_{Creep \text{ nom}}$	terminal to baseplate, nom.	40.0	mm
Creepage distance	$d_{Creep \text{ nom}}$	terminal to terminal, nom.	34.0	mm
Clearance	$d_{Clear \text{ nom}}$	terminal to baseplate, nom.	31.0	mm
Clearance	$d_{Clear \text{ nom}}$	terminal to terminal, nom.	8.0	mm
Comparative tracking index	CTI		> 600	

Table 2 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Stray inductance module	L_{sCE}			10		nH
Module lead resistance, terminals - chip	$R_{CC'EE'}$	$T_C = 25^\circ\text{C}$, per switch		0.43		mΩ
Storage temperature	T_{stg}		-40		150	°C
Maximum baseplate operation temperature	T_{BPmax}				150	°C
Mounting torque for module mounting	M	- Mounting according to valid application note	M6, Screw	4.25		Nm
Terminal connection torque	M	- Mounting according to valid application note	M3, Screw	0.9		Nm
			M8, Screw	8	1.1	
Weight	G			720		g

2 MOSFET

Table 3 Maximum rated values

Parameter	Symbol	Note or test condition	Values	Unit
Drain-source voltage	V_{DSS}	$T_{vj} = 25^\circ\text{C}$	3300	V
Implemented drain current	I_{DN}		750	A
Continuous DC drain current	I_{DDC}	$T_{vj} = 175^\circ\text{C}$, $V_{GS} = 15 \text{ V}$	720	A

(table continues...)

Table 3 (continued) Maximum rated values

Parameter	Symbol	Note or test condition	Values	Unit
Repetitive peak drain current	I_{DRM}	verified by design, t_p limited by T_{vjmax}	1500	A
Gate-source voltage, max. transient voltage	V_{GS}	$D < 0.01$	-10/23	V
Gate-source voltage, max. static voltage	V_{GS}		-7/20	V

Table 4 Recommended values

Parameter	Symbol	Note or test condition	Values	Unit
On-state gate voltage	$V_{GS(on)}$		15...18	V
Off-state gate voltage	$V_{GS(off)}$		-5	V

Table 5 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Drain-source on-resistance	$R_{DS(on)}$	$I_D = 750 \text{ A}$	$V_{GS} = 15 \text{ V}, T_{vj} = 25^\circ\text{C}$		2.5	3.1
			$V_{GS} = 15 \text{ V}, T_{vj} = 125^\circ\text{C}$		4.9	6.1
			$V_{GS} = 15 \text{ V}, T_{vj} = 175^\circ\text{C}$		7	8.8
Gate threshold voltage	$V_{GS(th)}$	$I_D = 675 \text{ mA}, V_{DS} = V_{GS}, T_{vj} = 25^\circ\text{C}, (\text{tested after } 1\text{ms pulse at } V_{GS} = +20 \text{ V})$	3.45	4.3	5.55	V
Total gate charge	Q_G	$V_{DD} = 1800 \text{ V}, V_{GS} = -5/15 \text{ V}$		3.75		μC
Internal gate resistor	R_{Gint}	$T_{vj} = 25^\circ\text{C}$		1		Ω
Input capacitance	C_{ISS}	$f = 100 \text{ kHz}, V_{DS} = 1800 \text{ V}, T_{vj} = 25^\circ\text{C}, V_{GS} = 0 \text{ V}$		152		nF
Output capacitance	C_{OSS}	$f = 100 \text{ kHz}, V_{DS} = 1800 \text{ V}, T_{vj} = 25^\circ\text{C}, V_{GS} = 0 \text{ V}$		2.1		nF
Reverse transfer capacitance	C_{rss}	$f = 100 \text{ kHz}, V_{DS} = 1800 \text{ V}, T_{vj} = 25^\circ\text{C}, V_{GS} = 0 \text{ V}$		0.086		nF
C_{OSS} stored energy	E_{OSS}	$V_{DS} = 1800 \text{ V}, V_{GS} = -5/15 \text{ V}, T_{vj} = 25^\circ\text{C}$		4.4		μJ
Drain-source leakage current	I_{DSS}	$V_{DS} = 3300 \text{ V}, V_{GS} = -5 \text{ V}$	$T_{vj} = 25^\circ\text{C}$		2000	μA
Gate-source leakage current	I_{GSS}	$V_{DS} = 0 \text{ V}, T_{vj} = 25^\circ\text{C}$	$V_{GS} = 20 \text{ V}$		10000	nA

(table continues...)

Table 5 (continued) Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Turn-on delay time (inductive load)	$t_{d\text{ on}}$	$I_D = 750 \text{ A}$, $R_{G\text{on}} = 0.5 \Omega$, $V_{DD} = 1800 \text{ V}$, $V_{GS} = -5/15 \text{ V}$	$T_{vj} = 25^\circ\text{C}$		490	ns
			$T_{vj} = 125^\circ\text{C}$		440	
			$T_{vj} = 175^\circ\text{C}$		440	
Rise time (inductive load)	t_r	$I_D = 750 \text{ A}$, $R_{G\text{on}} = 0.5 \Omega$, $V_{DD} = 1800 \text{ V}$, $V_{GS} = -5/15 \text{ V}$	$T_{vj} = 25^\circ\text{C}$		150	ns
			$T_{vj} = 125^\circ\text{C}$		180	
			$T_{vj} = 175^\circ\text{C}$		180	
Turn-off delay time (inductive load)	$t_{d\text{ off}}$	$I_D = 750 \text{ A}$, $R_{G\text{off}} = 1.2 \Omega$, $V_{DD} = 1800 \text{ V}$, $V_{GS} = -5/15 \text{ V}$	$T_{vj} = 25^\circ\text{C}$		280	ns
			$T_{vj} = 125^\circ\text{C}$		310	
			$T_{vj} = 175^\circ\text{C}$		320	
Fall time (inductive load)	t_f	$I_D = 750 \text{ A}$, $R_{G\text{off}} = 1.2 \Omega$, $V_{DD} = 1800 \text{ V}$, $V_{GS} = -5/15 \text{ V}$	$T_{vj} = 25^\circ\text{C}$		76	ns
			$T_{vj} = 125^\circ\text{C}$		76	
			$T_{vj} = 175^\circ\text{C}$		76	
Turn-on time (resistive load)	t_{on_R}	$I_D = 500 \text{ A}$, $V_{DD} = 2000 \text{ V}$, $V_{GS} = -5/15 \text{ V}$, $R_{G\text{on}} = 0.5 \Omega$	$T_{vj} = 25^\circ\text{C}$	0.39		μs
Turn-on energy loss per pulse	E_{on}	$I_D = 750 \text{ A}$, $V_{DD} = 1800 \text{ V}$, $L_\sigma = 30 \text{ nH}$, $V_{GS} = -5/15 \text{ V}$, $R_{G\text{on}} = 0.5 \Omega$, $di/dt = 9.1 \text{ kA}/\mu\text{s}$ ($T_{vj} = 175^\circ\text{C}$)	$T_{vj} = 25^\circ\text{C}$		160	mJ
			$T_{vj} = 125^\circ\text{C}$		210	
			$T_{vj} = 175^\circ\text{C}$		260	
Turn-off energy loss per pulse	E_{off}	$I_D = 750 \text{ A}$, $V_{DD} = 1800 \text{ V}$, $L_\sigma = 30 \text{ nH}$, $V_{GS} = -5/15 \text{ V}$, $R_{G\text{off}} = 1.2 \Omega$, $dv/dt = 21 \text{ kV}/\mu\text{s}$ ($T_{vj} = 175^\circ\text{C}$)	$T_{vj} = 25^\circ\text{C}$		100	mJ
			$T_{vj} = 125^\circ\text{C}$		100	
			$T_{vj} = 175^\circ\text{C}$		100	
SC data	I_{SC}	$V_{GS} = -5/15 \text{ V}$, $V_{DD} = 2400 \text{ V}$, $V_{DS\text{max}} = V_{DSS} - L_{sDS} * di/dt$, $R_G = 0.5 \Omega$	$t_p = 3 \mu\text{s}$, $T_{vj} = 175^\circ\text{C}$		6600	A
Thermal resistance, junction to case	R_{thJC}	per MOSFET			33.0	K/kW
Thermal resistance, case to heat sink	R_{thCH}	per MOSFET, $\lambda_{grease} = 1 \text{ W}/(\text{m}^*\text{K})$		25.8		K/kW
Temperature under switching conditions	$T_{vj\text{ op}}$		-40		175	°C

3 Body diode (MOSFET)

Table 6 Maximum rated values

Parameter	Symbol	Note or test condition		Values		Unit
DC body diode forward current	I_{SD}	$T_{vj} = 175 \text{ }^\circ\text{C}$, $V_{GS} = -5 \text{ V}$		750		A
I^2t -value	I^2t	$V_{DS} = 0 \text{ V}$, $V_{GS} = -5 \text{ V}$, $t_P = 10 \text{ ms}$		280		kA^2s

Table 7 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Forward voltage	V_{SD}	$I_{SD} = 750 \text{ A}$, $V_{GS} = -5 \text{ V}$	$T_{vj} = 25 \text{ }^\circ\text{C}$		4.6	5.8
			$T_{vj} = 125 \text{ }^\circ\text{C}$		3.9	4.9
			$T_{vj} = 175 \text{ }^\circ\text{C}$		3.6	4.5
Reverse recovery energy	E_{rec}	$I_{SD} = 750 \text{ A}$, $dI_s/dt = 9.1 \text{ kA}/\mu\text{s}$ ($T_{vj} = 175 \text{ }^\circ\text{C}$), $V_{DD} = 1800 \text{ V}$, $V_{GS} = -5 \text{ V}$	$T_{vj} = 25 \text{ }^\circ\text{C}$		21	mJ
			$T_{vj} = 125 \text{ }^\circ\text{C}$		33	
			$T_{vj} = 175 \text{ }^\circ\text{C}$		56	

4 NTC-Thermistor

Table 8 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Rated resistance	R_{25}	$T_{NTC} = 25 \text{ }^\circ\text{C}$		5		$\text{k}\Omega$
Deviation of R_{100}	$\Delta R/R$	$T_{NTC} = 100 \text{ }^\circ\text{C}$, $R_{100} = 493 \Omega$	-5		5	%
Power dissipation	P_{25}	$T_{NTC} = 25 \text{ }^\circ\text{C}$			20	mW
B-value	$B_{25/50}$	$R_2 = R_{25} \exp[B_{25/50}(1/T_2 - 1/(298,15 \text{ K}))]$		3375		K
B-value	$B_{25/80}$	$R_2 = R_{25} \exp[B_{25/80}(1/T_2 - 1/(298,15 \text{ K}))]$		3411		K
B-value	$B_{25/100}$	$R_2 = R_{25} \exp[B_{25/100}(1/T_2 - 1/(298,15 \text{ K}))]$		3433		K

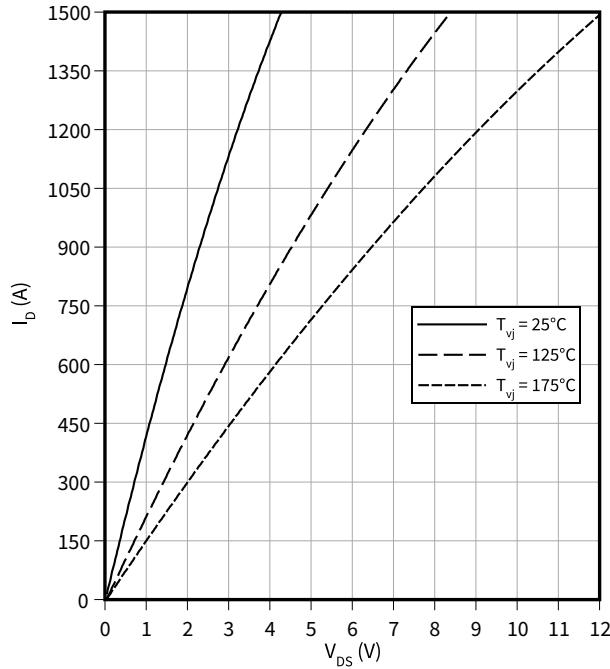
Note: Specification according to the valid application note.

5 Characteristics diagrams

Output characteristic (typical), MOSFET

$$I_D = f(V_{DS})$$

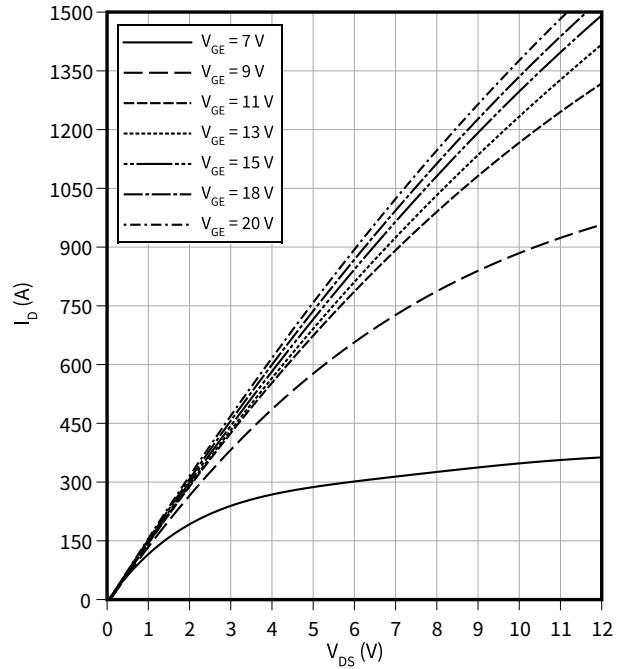
$$V_{GS} = 15 \text{ V}$$



Output characteristic field (typical), MOSFET

$$I_D = f(V_{DS})$$

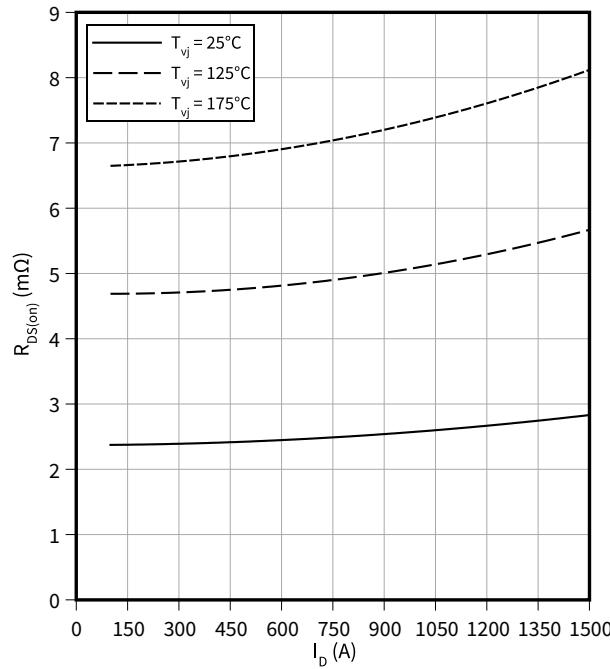
$$T_{vj} = 175 \text{ °C}$$



Drain source on-resistance (typical), MOSFET

$$R_{DS(on)} = f(I_D)$$

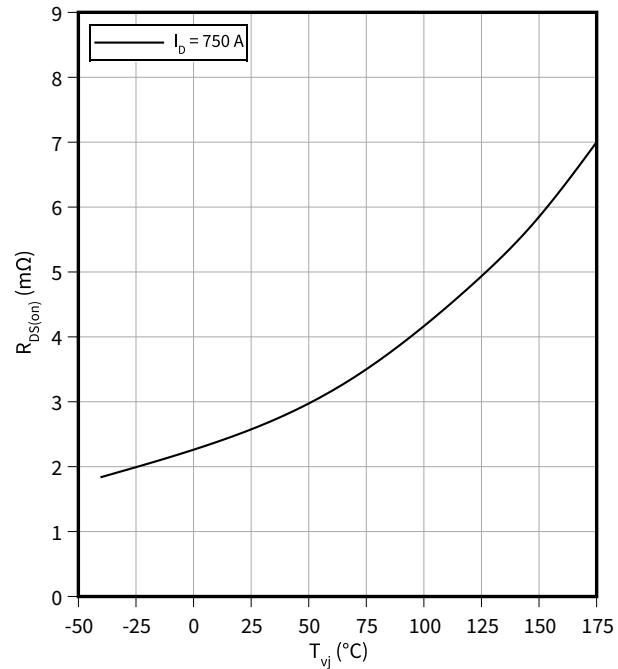
$$V_{GS} = 15 \text{ V}$$



Drain source on-resistance (typical), MOSFET

$$R_{DS(on)} = f(T_{vj})$$

$$V_{GS} = 15 \text{ V}$$

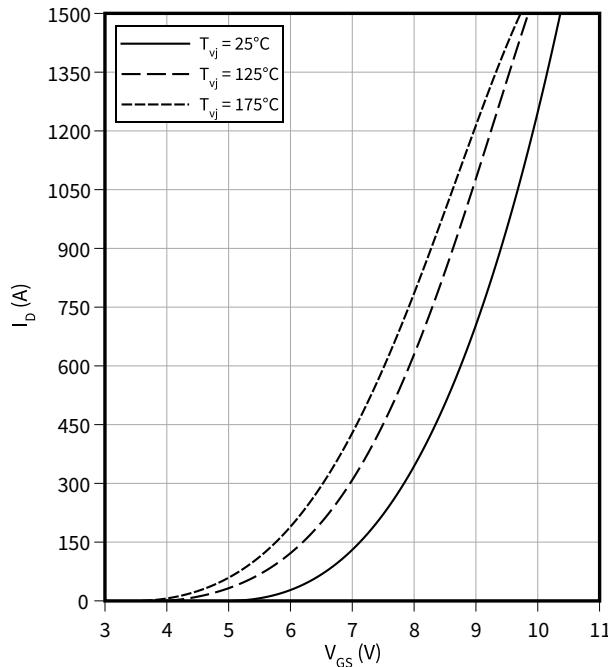


5 Characteristics diagrams

Transfer characteristic (typical), MOSFET

$$I_D = f(V_{GS})$$

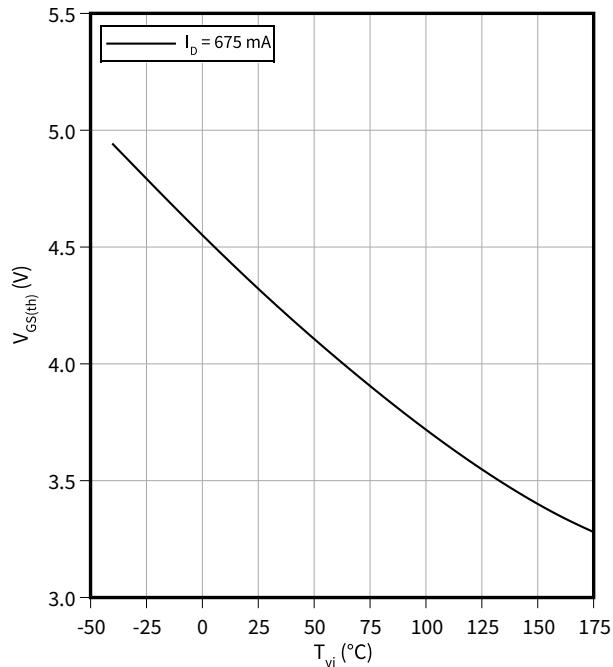
$$V_{DS} = 20 \text{ V}$$



Gate-source threshold voltage (typical), MOSFET

$$V_{GS(th)} = f(T_{vj})$$

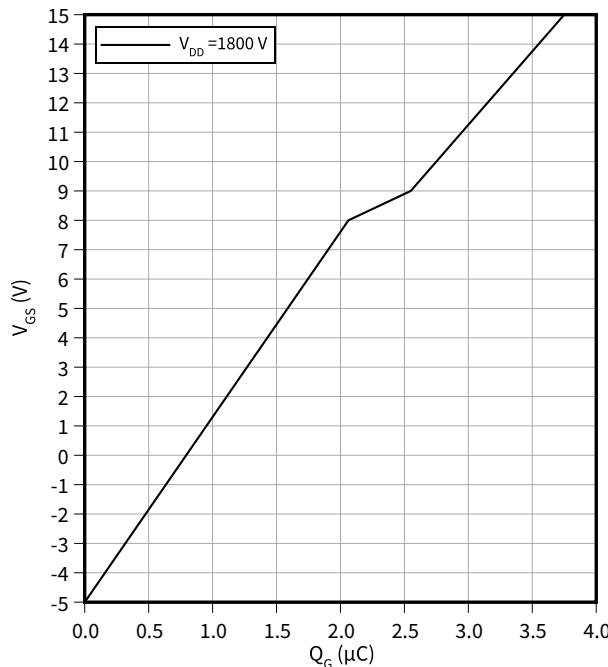
$$V_{GS} = V_{DS}$$



Gate charge characteristic (typical), MOSFET

$$V_{GS} = f(Q_G)$$

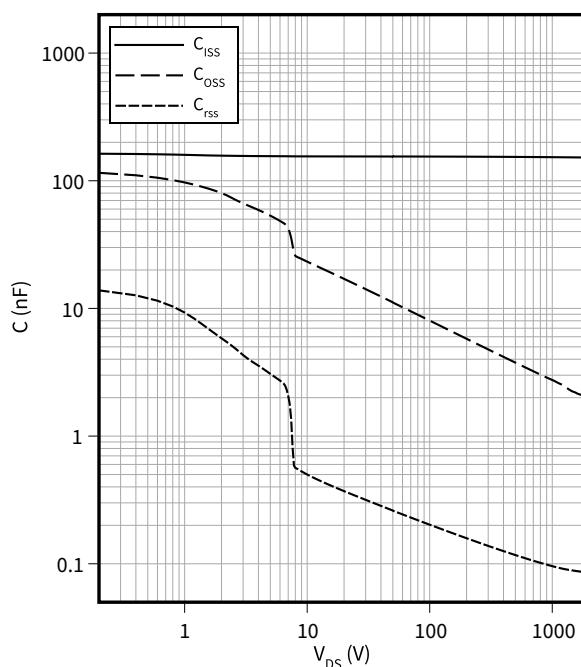
$$I_D = 750 \text{ A}, T_{vj} = 25 \text{ °C}$$



Capacity characteristic (typical), MOSFET

$$C = f(V_{DS})$$

$$f = 100 \text{ kHz}, T_{vj} = 25 \text{ °C}, V_{GS} = 0 \text{ V}$$

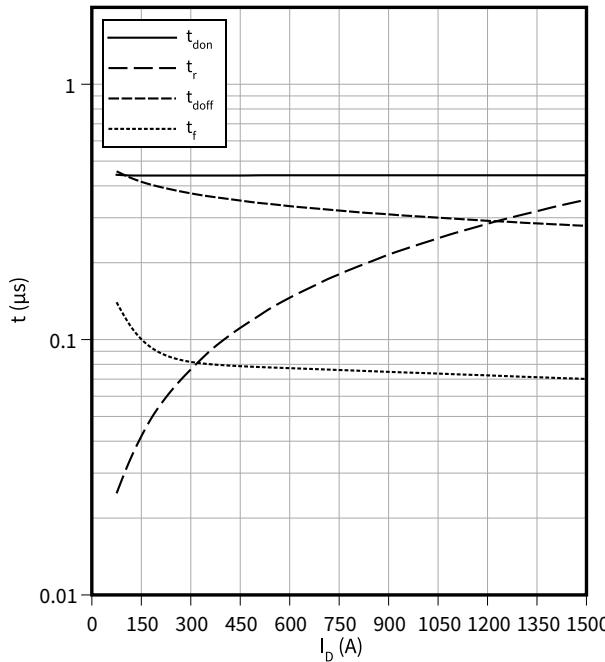


5 Characteristics diagrams

Switching times (typical), MOSFET

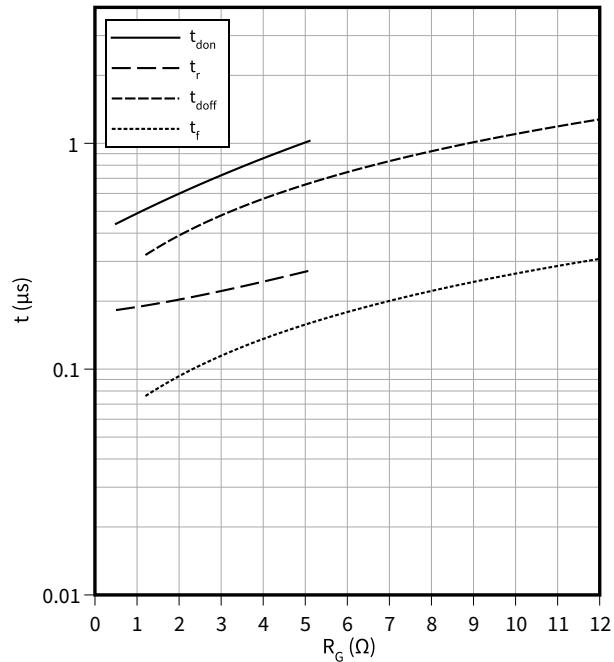
$$t = f(I_D)$$

$R_{Goff} = 1.2 \Omega$, $R_{Gon} = 0.5 \Omega$, $V_{DD} = 1800 \text{ V}$, $T_{vj} = 175^\circ\text{C}$, $V_{GS} = -5/15 \text{ V}$

**Switching times (typical), MOSFET**

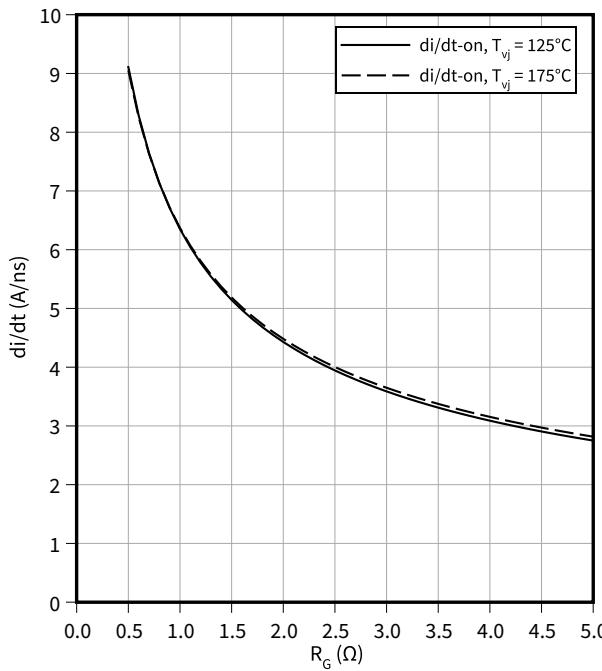
$$t = f(R_G)$$

$V_{DD} = 1800 \text{ V}$, $I_D = 750 \text{ A}$, $T_{vj} = 175^\circ\text{C}$, $V_{GS} = -5/15 \text{ V}$

**Current slope (typical), MOSFET**

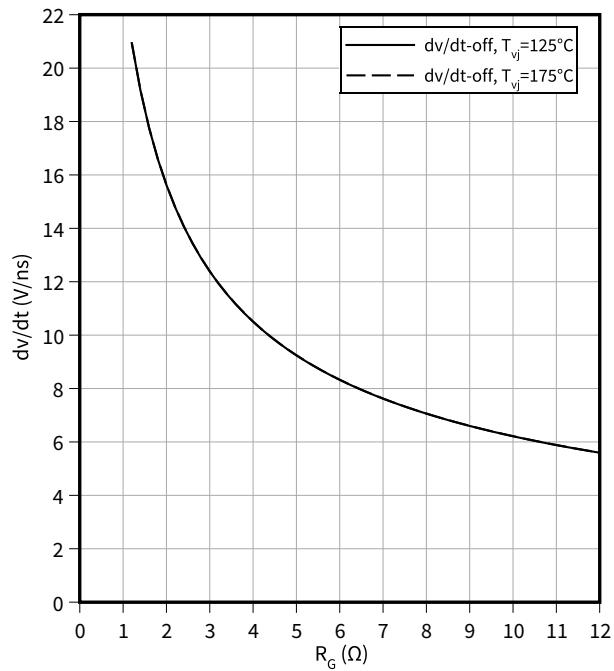
$$di/dt = f(R_G)$$

$V_{DD} = 1800 \text{ V}$, $I_D = 750 \text{ A}$, $V_{GS} = -5/15 \text{ V}$

**Voltage slope (typical), MOSFET**

$$dv/dt = f(R_G)$$

$V_{DD} = 1800 \text{ V}$, $I_D = 750 \text{ A}$, $V_{GS} = -5/15 \text{ V}$

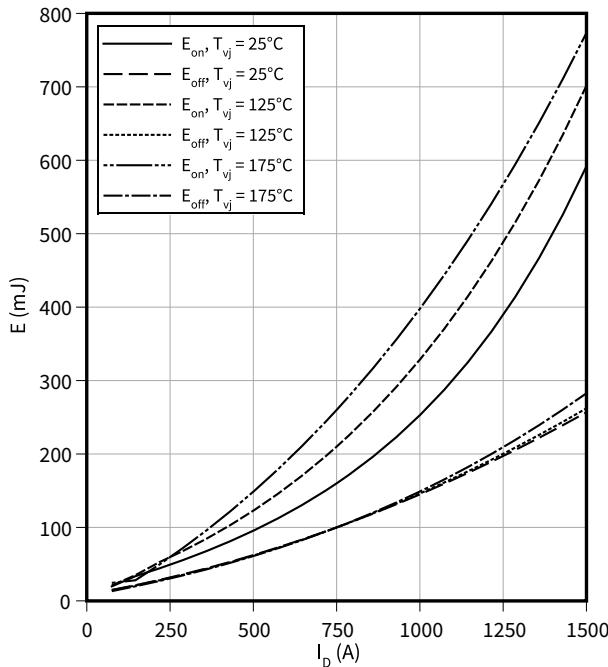


5 Characteristics diagrams

Switching losses (typical), MOSFET

$$E = f(I_D)$$

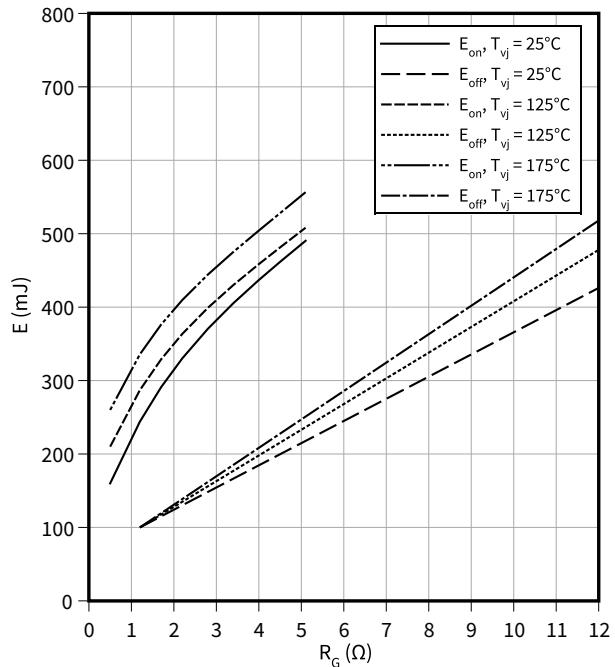
$R_{Goff} = 1.2 \Omega$, $R_{Gon} = 0.5 \Omega$, $V_{DD} = 1800 \text{ V}$, $V_{GS} = -5/15 \text{ V}$



Switching losses (typical), MOSFET

$$E = f(R_G)$$

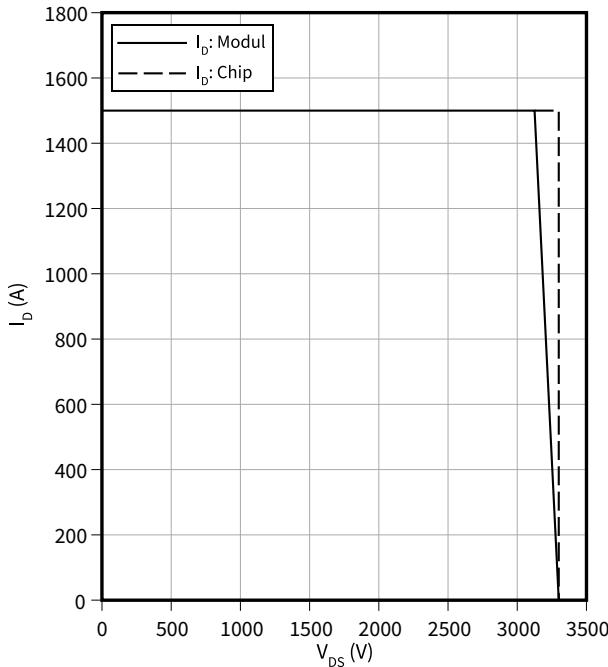
$V_{DD} = 1800 \text{ V}$, $I_D = 750 \text{ A}$, $V_{GS} = -5/15 \text{ V}$



Reverse bias safe operating area (RBSOA), MOSFET

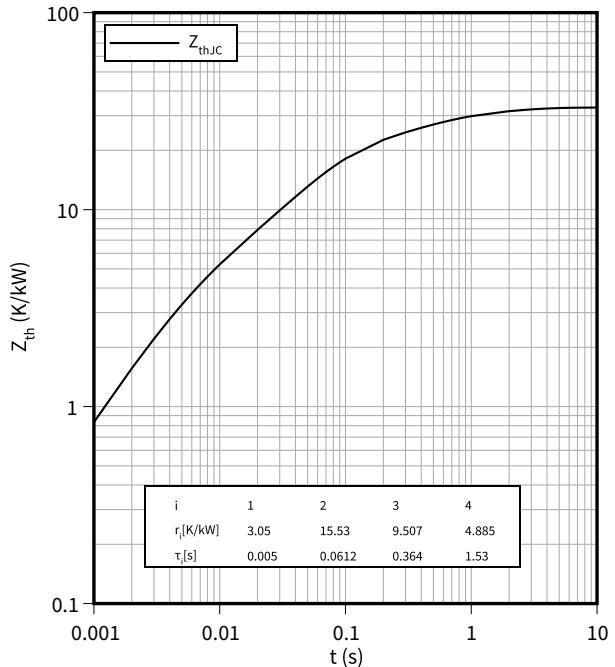
$$I_D = f(V_{DS})$$

$R_{Goff} = 1.2 \Omega$, $T_{vj} = 175^\circ\text{C}$, $V_{GS} = -5/15 \text{ V}$



Transient thermal impedance, MOSFET

$$Z_{th} = f(t)$$

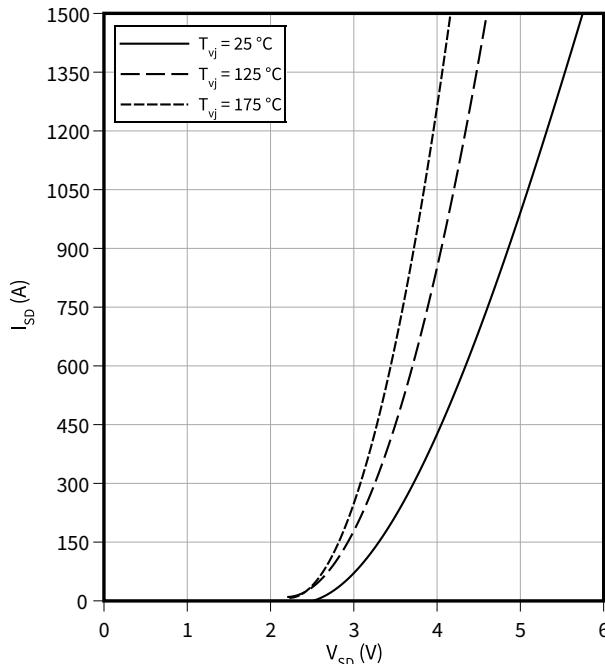


5 Characteristics diagrams

Forward characteristic body diode (typical), MOSFET

$$I_{SD} = f(V_{SD})$$

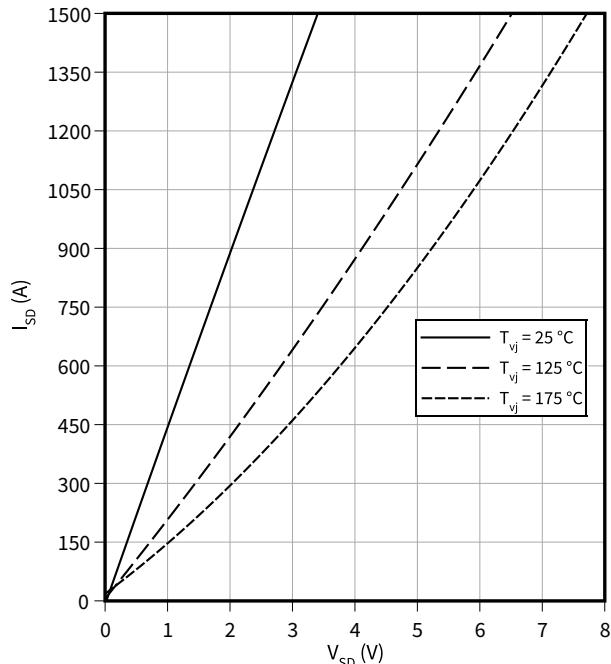
$$V_{GS} = -5 \text{ V}$$



Forward characteristic body diode (typical), MOSFET

$$I_{SD} = f(V_{SD})$$

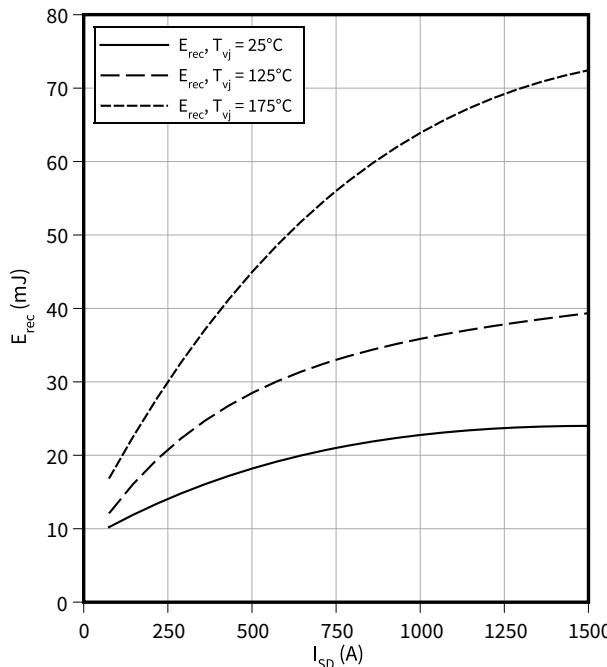
$$V_{GS} = 15 \text{ V}$$



Switching losses body diode (typical), MOSFET

$$E_{rec} = f(I_{SD})$$

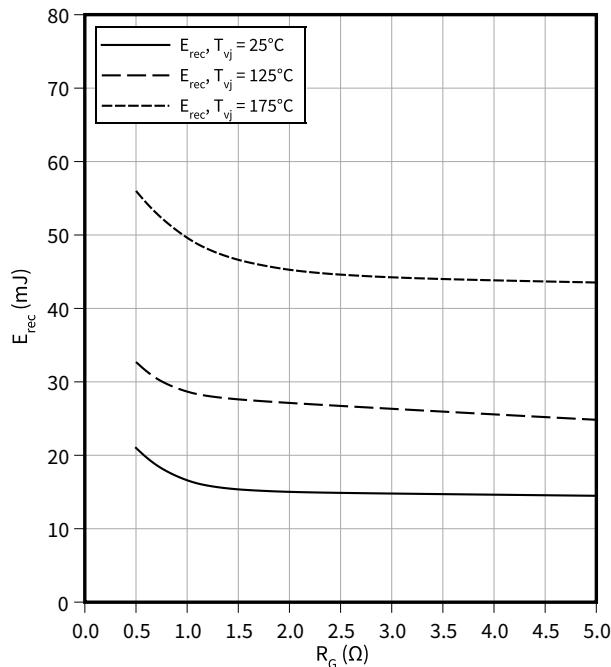
$$R_{Gon} = 0.5 \Omega, V_{DD} = 1800 \text{ V}$$



Switching losses body diode (typical), MOSFET

$$E_{rec} = f(R_G)$$

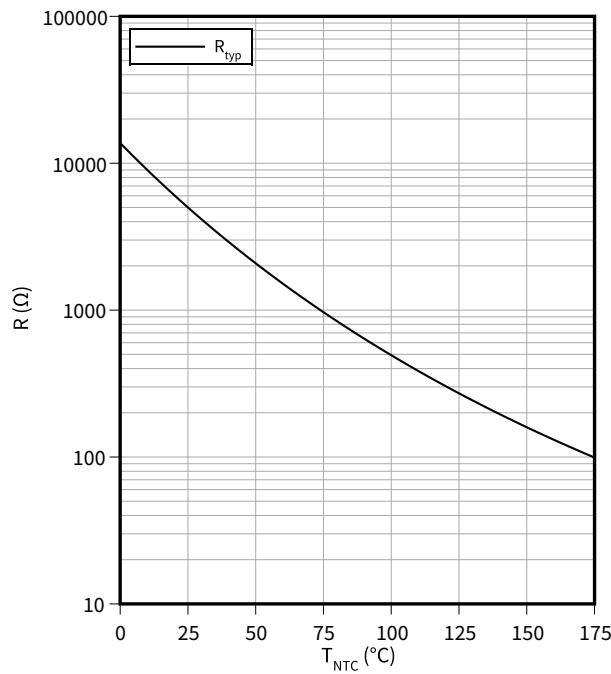
$$V_{DD} = 1800 \text{ V}, I_{SD} = 750 \text{ A}$$



5 Characteristics diagrams

Temperature characteristic (typical), NTC-Thermistor

$$R = f(T_{NTC})$$



6 Circuit diagram

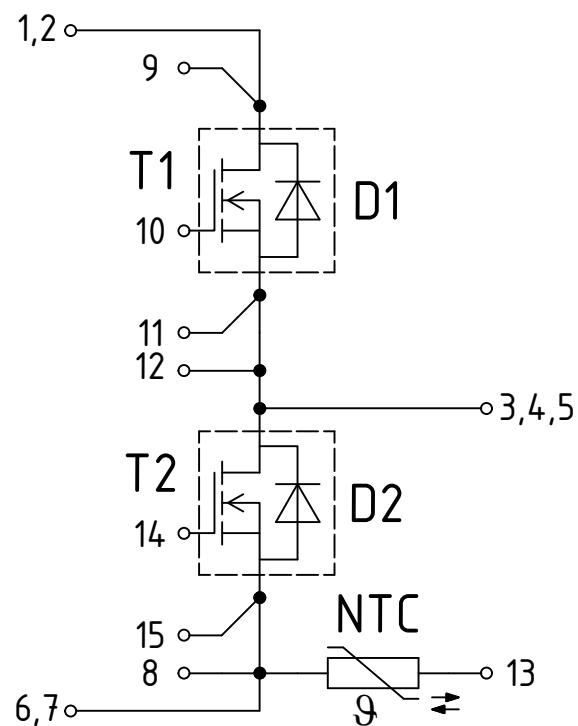


Figure 1

7 Package outlines

7 Package outlines

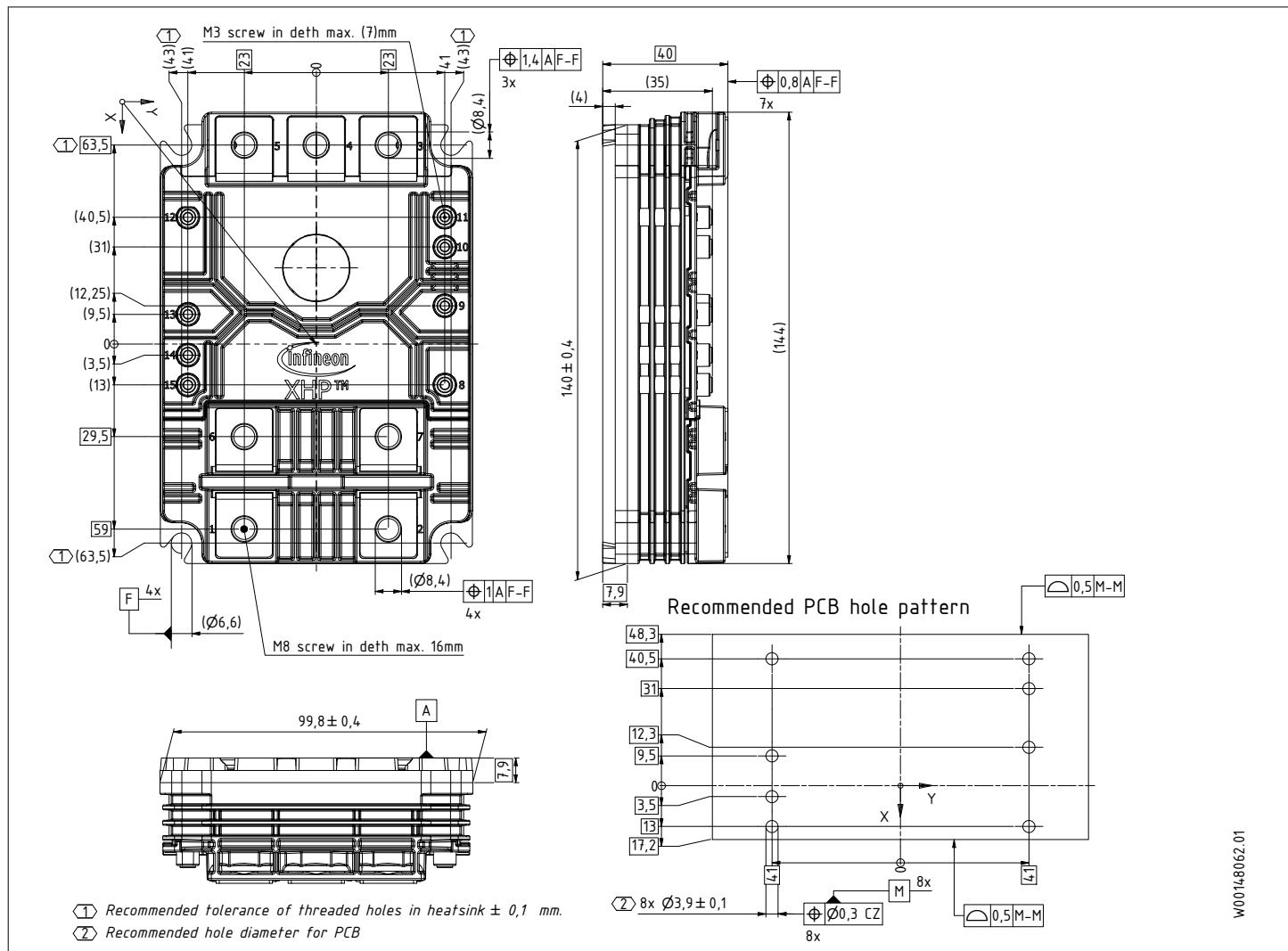


Figure 2

8 Module label code

Module label code			
Code format	Data Matrix		Barcode Code128
Encoding	ASCII text		Code Set A
Symbol size	16x16		23 digits
Standard	IEC24720 and IEC16022		IEC8859-1
Code content	<i>Content</i> Module serial number Module material number Production order number Date code (production year) Date code (production week)	<i>Digit</i> 1 – 5 6 - 11 12 - 19 20 – 21 22 – 23	<i>Example</i> 71549 142846 55054991 15 30
Example	 71549142846550549911530	 71549142846550549911530	

Figure 3

Revision history

Revision history

Document revision	Date of release	Description of changes
V1.0	2020-04-23	Target datasheet
n/a	2020-09-01	Datasheet migrated to a new system with a new layout and new revision number schema: target or preliminary datasheet = 0.xy; final datasheet = 1.xy
0.20	2023-11-21	Preliminary datasheet
1.00	2024-04-16	Final datasheet

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